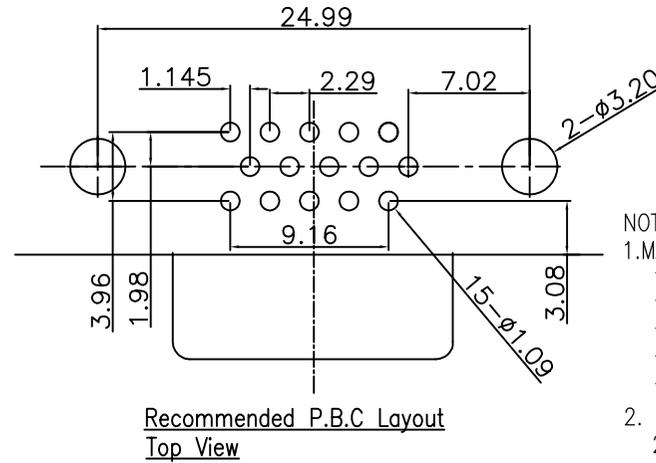
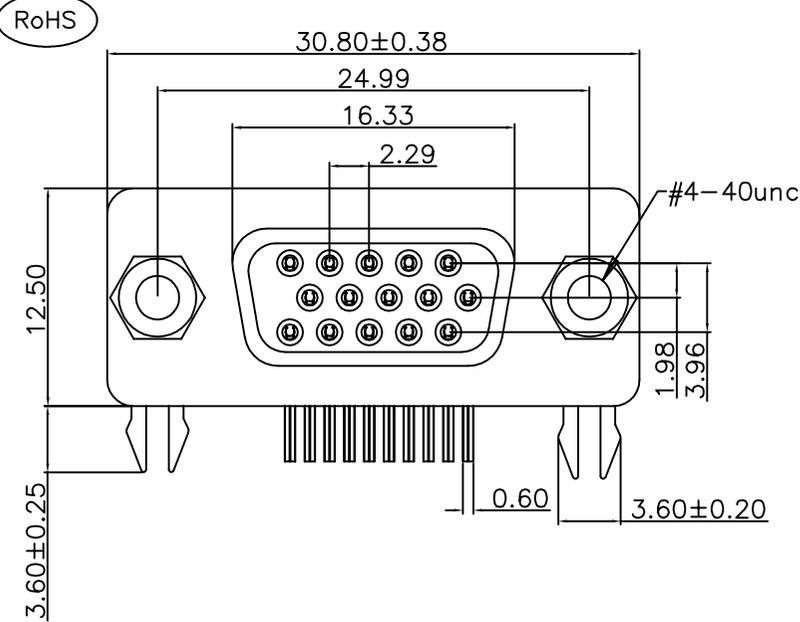


The product using material and processing must conform to the "WI-PZ-001" HSF technical standard control requirements



NOTE:

1. MATERIAL:

- 1.1 HOUSING: PBT+30%GF, UL94V-0, COLOR: BLACK.
- 1.2 TERMINAL: COPPER ALLOY.
- 1.3 SHELL: SPCC
- 1.4 SCREW: SPCC
- 1.5 GROUNDING: SPCC

2. PLATING:

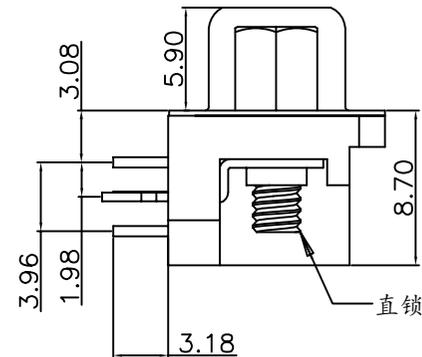
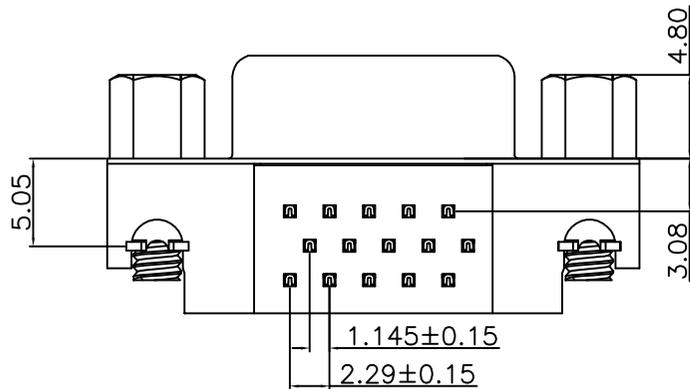
- 2.1 CONTACT:
80u" Min. TIN PLATED ON SOLDER TAIL
50u" Min. NICKEL UNDER-PLATED
- 2.2 SHELL: 50u" Min, NICKEL PLATED OVERALL
- 2.3 GROUNDING: 50u" Min, TIN PLATED OVERALL.
- 2.4 SCREW: 50u" Min, NICKEL PLATED OVERALL.

3. SPECIFICATIONS:

- VOLTAGE: 500 VAC(RMS) MAX.
- CURRENT RATING: 3 AMPERE PER CONTACT
- CONTACT RESISTANCE: 30 MILLIOHMS MAX.
- INSULATION RESISTANCE: 1000 MEGOHMS MIN.
- DIELECTRIC WITHSTANDING VOLTAGE: 500V AC(RMS)
- MATING FORCE: 5.1Kg.Max.
- UNMATING FORCE: 1.0Kg MIN.
- OPERATING TEMPERATURE: -25° ~ +85°

P/N: WLDBF9-15 1 X X 0 130

PLATING: 7-Sn COLOUR: A-BLACK



REV.	REVISION RECORD	DATE	UNIT:mm	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Teconology Co., Ltd	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	1:1	APPROVED	Wang_jr				21.01.13
			0.00±0.25	X'±3'		DESIGNER	Han_Gao	21.01.13	WLDBF9-151XX0130	ENDE05		TITLE:
			0.000±0.10	X'X' ±2'		DRAWN	Zijun_Huang	21.01.13				